



DEVICE TYPE:				<b>SEMPAC, INC.</b> Open-Pak™ Technologies <a href="http://www.sempac.com">www.sempac.com</a> 568 E. WEDDELL DRIVE, SUITE 5 SUNNYVALE, CALIFORNIA 94089 PHONE: (408) 400-9002 FAX: (408) 400-9006					
CUSTOMER:			DIE SIZE:						
WIRE TYPE/ SIZE:			NO. OF WIRES:						
THIRD ANGLE PROJECTION	REVISIONS					24 Lead 5.00mm x 5.00mm MLP Open-Pak Bonding Diagram			
	ECN NO.	DATE	DESCRIPTION	APPROVED					
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETER DO NOT SCALE DRAWING	10482	10/26/05	PRODUCTION RELEASE	D.BENANDO					
DRAWN BY W. GRIFFITTS	DATE 10/26/05	PACKAGE SIZE: 5.00mm x 5.00mm	SIZE A	PART NO. MLP5X5-24-OP-01	REV 2				
APP BY P. FLASKERUD	DATE 10/26/05	DIE PAD SIZE: 3.10mm x 3.10mm	SCALE 32X	CAD FILE MLP5X5-24-OP-01-B-R2.DWG	SHEET 1 OF 1				